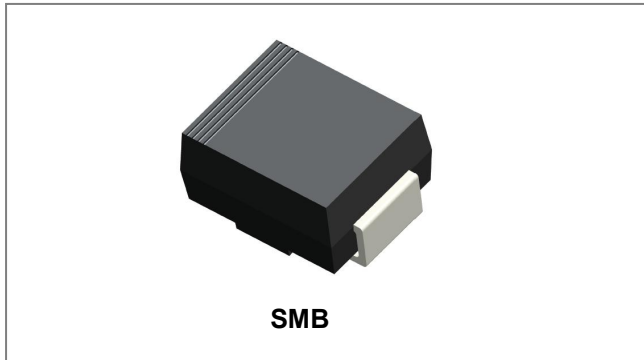


## SD260B STANDARD RECTIFIER



### Features

- Glass Passivated Die Construction
- Ideally Suited for Automatic Assembly
- Low Forward Voltage Drop
- Low Power Loss
- Built Strain Relief
- Plastic Case Material has UL Flammability Classification Rating 94V-0
- This is a Pb – Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

### Circuit Diagram



### Mechanical Data

- Case: SMB molded plastic body
- Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
- Polarity: Color band denotes cathode end
- Mounting Position: Any
- Weight: 0.09 grams

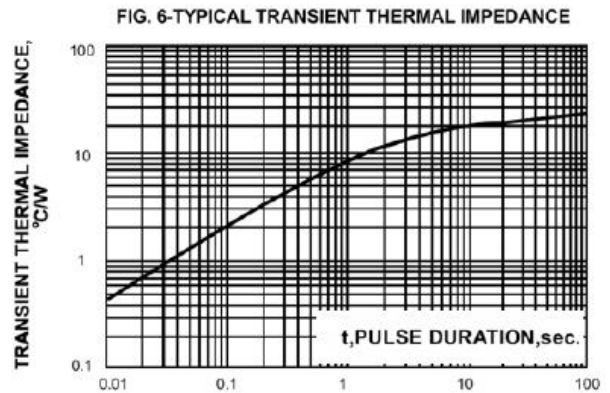
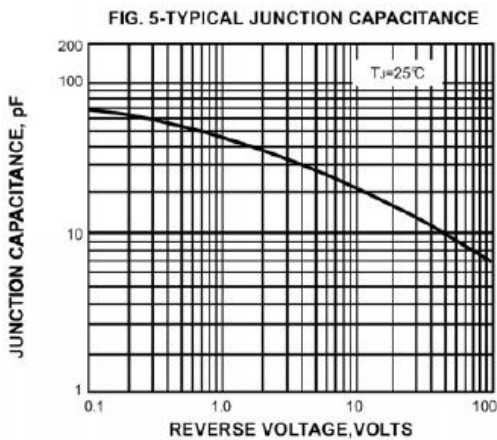
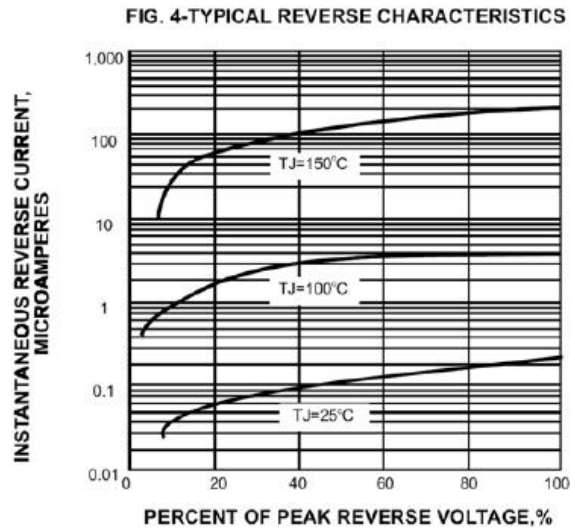
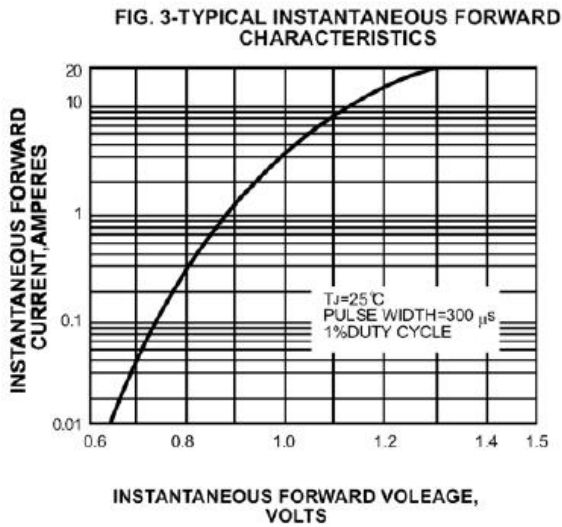
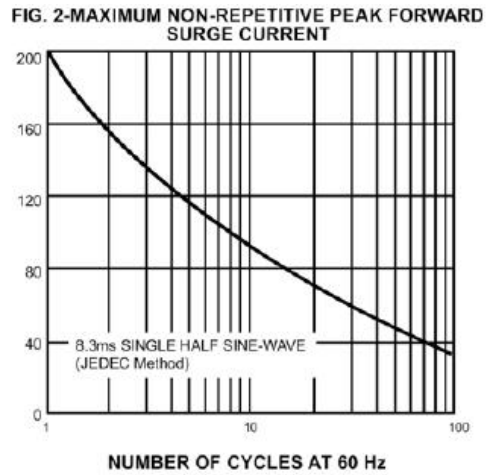
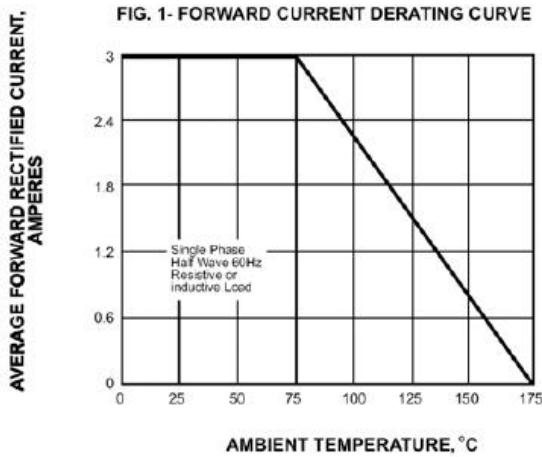
### Maximum Ratings and Electrical Characteristics @T<sub>A</sub>=25°C unless otherwise specified

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

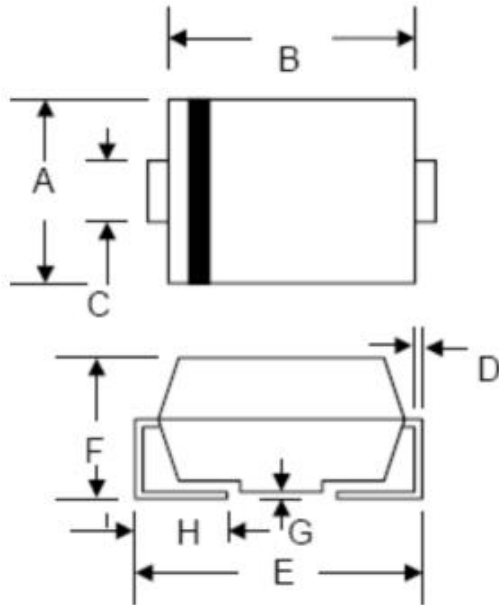
Characteristic	Symbol	SD260B	Units
Maximum repetitive peak reverse voltage Maximum DC blocking voltage	$V_{RRM}$ $V_{DC}$	600	V
Maximum RMS voltage	$V_{RMS}$	420	V
Maximum average forward rectified current 0.375"(9.5mm) lead length @T <sub>A</sub> = 75°C	$I_{(AV)}$	2.0	A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	$I_{FSM}$	120	A
Maximum instantaneous forward voltage at 2.0A	$V_F$	1.2	V
Maximum DC reverse current @T <sub>A</sub> = 25°C at rated DC blocking voltage @T <sub>A</sub> = 100°C	$I_R$	5 100	μA
Typical Junction Capacitance (Note 1)	$C_J$	30	pF
Typical Thermal Resistance (Note 2)	$R_{\theta JA}$	20	°C/W
Operating and Storage Temperature Range	$T_J, T_{STG}$	-65 to +175	°C

Note: 1. Measured at 1MHz and applied reverse voltage of 4.0V D.C.  
 2. Thermal resistance from junction to ambient at 0.375"(9.5mm)lead length, P.C.B. mounted.

**Ratings and Characteristics Curves**



**Mechanical Dimensions SMB**



SYMBOL	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	3.30	3.94	0.130	0.155
B	4.06	4.70	0.160	0.185
C	1.80	2.20	0.071	0.087
D	0.152	0.305	0.006	0.012
E	4.80	5.59	0.189	0.220
F	2.10	2.60	0.083	0.102
G	0.051	0.203	0.002	0.008
H	0.76	1.52	0.030	0.060

**Ordering Information**

Device	Package	Shipping
SD260B	SMB(Pb-Free)	3000pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

**Marking Diagram**

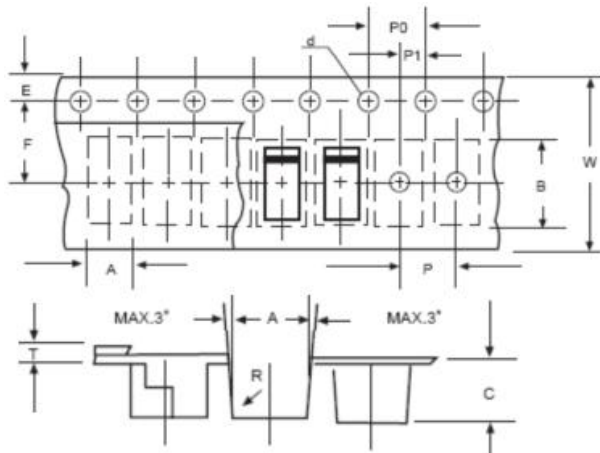


Where XXXXX is YYWWL

SD260B = Part Name  
YY = Year  
WW = Week  
L = Lot Number

**Cautions:** Molding resin  
Epoxy resin UL:94V-0

**Carrier Tape Specification SMB**



SYMBOL	Millimeters	
	Min.	Max.
A	3.99	4.19
B	5.72	5.92
C	3.23	3.43
d	1.40	1.60
E	1.40	1.60
F	5.60	5.70
P	7.90	8.10
P0	3.90	4.10
P1	1.90	2.10
T	-	0.60
W	11.80	12.20

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